

Docket No. 0010-1098-0

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IN THE CLAIMS

Please cancel Claims 3-10, without prejudice toward the further prosecution of these claims in a Continuation and/or Divisional Application.

Please amend the claims as follows:

--20. (Amended) The [method] multilayer printed-wiring board of Claim 19, wherein said plasma-treated insulating layer has a surface roughness of 100 nm to 4,000 nm.--

Please add the following new claims:

--23. (New) to 26. (New)--